

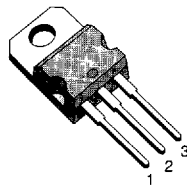
# N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTOR

| TYPE        | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-------------|------------------|---------------------|----------------|
| STP60N05-16 | 50 V             | < 0.016 $\Omega$    | 60 A           |
| STP60N06-16 | 60 V             | < 0.016 $\Omega$    | 60 A           |

- TYPICAL R<sub>DS(on)</sub> = 0.013  $\Omega$
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- LOW GATE CHARGE
- VERY HIGH CURRENT CAPABILITY
- APPLICATION ORIENTED CHARACTERIZATION

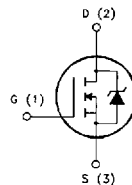
## APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- REGULATORS
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, Etc.)



TO-220

## INTERNAL SCHEMATIC DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

| Symbol              | Parameter                                              | Value       |             | Unit |
|---------------------|--------------------------------------------------------|-------------|-------------|------|
|                     |                                                        | STP60N05-16 | STP60N06-16 |      |
| V <sub>DS</sub>     | Drain-source Voltage (V <sub>GS</sub> = 0)             | 50          | 60          | V    |
| V <sub>DGR</sub>    | Drain- gate Voltage (R <sub>GS</sub> = 20 k $\Omega$ ) | 50          | 60          | V    |
| V <sub>GS</sub>     | Gate-source Voltage                                    | $\pm 20$    |             | V    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 25 °C   | 60          |             | A    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 100 °C  | 42          |             | A    |
| I <sub>DM</sub> (*) | Drain Current (pulsed)                                 | 240         |             | A    |
| P <sub>tot</sub>    | Total Dissipation at T <sub>c</sub> = 25 °C            | 150         |             | W    |
|                     | Derating Factor                                        |             |             | W/°C |
| T <sub>stg</sub>    | Storage Temperature                                    | -65 to 175  |             | °C   |
| T <sub>j</sub>      | Max. Operating Junction Temperature                    | 175         |             | °C   |

(\*) Pulse width limited by safe operating area

# **THERMAL DATA**

|                |                                                |     |      |               |
|----------------|------------------------------------------------|-----|------|---------------|
| $R_{thj-case}$ | Thermal Resistance Junction-case               | Max | 1    | $^{\circ}C/W$ |
| $R_{thj-amb}$  | Thermal Resistance Junction-ambient            | Max | 62.5 | $^{\circ}C/W$ |
| $R_{thj-amb}$  | Thermal Resistance Case-sink                   | Typ | 0.5  | $^{\circ}C/W$ |
| $T_l$          | Maximum Lead Temperature For Soldering Purpose |     | 300  | $^{\circ}C$   |

## **AVALANCHE CHARACTERISTICS**

| Symbol   | Parameter                                                                                                                   | Max Value | Unit |
|----------|-----------------------------------------------------------------------------------------------------------------------------|-----------|------|
| $I_{AR}$ | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max, $\delta < 1\%$ )                         | 60        | A    |
| $E_{AS}$ | Single Pulse Avalanche Energy (starting $T_j = 25^{\circ}C$ , $I_D = I_{AR}$ , $V_{DD} = 25 V$ )                            | 600       | mJ   |
| $E_{AR}$ | Repetitive Avalanche Energy (pulse width limited by $T_j$ max, $\delta < 1\%$ )                                             | 150       | mJ   |
| $I_{AR}$ | Avalanche Current, Repetitive or Not-Repetitive ( $T_c = 100^{\circ}C$ , pulse width limited by $T_j$ max, $\delta < 1\%$ ) | 42        | A    |

## **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25^{\circ}C$ unless otherwise specified)

OFF

| Symbol        | Parameter                                        | Test Conditions                                                                              | Min.     | Typ. | Max.        | Unit               |
|---------------|--------------------------------------------------|----------------------------------------------------------------------------------------------|----------|------|-------------|--------------------|
| $V_{(BR)DSS}$ | Drain-source Breakdown Voltage                   | $I_D = 250 \mu A$ $V_{GS} = 0$<br>for <b>STP60N05-16</b><br>for <b>STP60N06-16</b>           | 50<br>60 |      |             | V<br>V             |
| $I_{DSS}$     | Zero Gate Voltage Drain Current ( $V_{GS} = 0$ ) | $V_{DS} = \text{Max Rating}$<br>$V_{DS} = \text{Max Rating} \times 0.8$ $T_c = 125^{\circ}C$ |          |      | 250<br>1000 | $\mu A$<br>$\mu A$ |
| $I_{GSS}$     | Gate-body Leakage Current ( $V_{DS} = 0$ )       | $V_{GS} = \pm 20 V$                                                                          |          |      | $\pm 100$   | nA                 |

ON (\*)

| Symbol       | Parameter                         | Test Conditions                                                                   | Min. | Typ.  | Max.           | Unit                 |
|--------------|-----------------------------------|-----------------------------------------------------------------------------------|------|-------|----------------|----------------------|
| $V_{GS(th)}$ | Gate Threshold Voltage            | $V_{DS} = V_{GS}$ $I_D = 250 \mu A$                                               | 2    | 2.9   | 4              | V                    |
| $R_{DS(on)}$ | Static Drain-source On Resistance | $V_{GS} = 10 V$ $I_D = 30 A$<br>$V_{GS} = 10 V$ $I_D = 30 A$ $T_c = 100^{\circ}C$ |      | 0.013 | 0.016<br>0.032 | $\Omega$<br>$\Omega$ |
| $I_{D(on)}$  | On State Drain Current            | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$<br>$V_{GS} = 10 V$                      | 60   |       |                | A                    |

## **DYNAMIC**

| Symbol       | Parameter                    | Test Conditions                                        | Min. | Typ. | Max. | Unit |
|--------------|------------------------------|--------------------------------------------------------|------|------|------|------|
| $g_{fs} (*)$ | Forward Transconductance     | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 30 A$ | 20   | 40   |      | S    |
| $C_{iss}$    | Input Capacitance            | $V_{DS} = 25 V$ $f = 1 MHz$ $V_{GS} = 0$               |      | 2900 | 3800 | pF   |
| $C_{oss}$    | Output Capacitance           |                                                        |      | 900  | 1200 | pF   |
| $C_{rss}$    | Reverse Transfer Capacitance |                                                        |      | 280  | 300  | pF   |

ELECTRICAL CHARACTERISTICS (continued)  
SWITCHING ON

| Symbol         | Parameter             | Test Conditions                                                                                                         | Min. | Typ. | Max. | Unit       |
|----------------|-----------------------|-------------------------------------------------------------------------------------------------------------------------|------|------|------|------------|
| $t_{d(on)}$    | Turn-on Time          | $V_{DD} = 30\text{ V}$ $I_D = 30\text{ A}$                                                                              |      | 75   | 105  | ns         |
| $t_r$          | Rise Time             | $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 3)                                               |      | 370  | 520  | ns         |
| $(di/dt)_{on}$ | Turn-on Current Slope | $V_{DD} = 40\text{ V}$ $I_D = 60\text{ A}$<br>$R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 5) |      | 190  |      | A/ $\mu$ s |
| $Q_g$          | Total Gate Charge     | $V_{DD} = 40\text{ V}$ $I_D = 60\text{ A}$ $V_{GS} = 10\text{ V}$                                                       |      | 105  | 150  | nC         |
| $Q_{gs}$       | Gate-Source Charge    |                                                                                                                         |      | 18   |      | nC         |
| $Q_{gd}$       | Gate-Drain Charge     |                                                                                                                         |      | 44   |      | nC         |

SWITCHING OFF

| Symbol       | Parameter             | Test Conditions                            | Min. | Typ. | Max. | Unit |
|--------------|-----------------------|--------------------------------------------|------|------|------|------|
| $t_{r(off)}$ | Off-voltage Rise Time | $V_{DD} = 40\text{ V}$ $I_D = 60\text{ A}$ |      | 185  | 260  | ns   |
| $t_f$        | Fall Time             | $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$  |      | 250  | 350  | ns   |
| $t_c$        | Cross-over Time       | (see test circuit, figure 5)               |      | 480  | 680  | ns   |

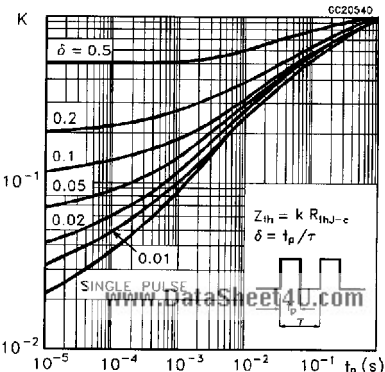
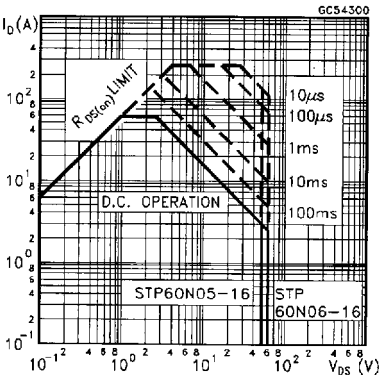
SOURCE DRAIN DIODE

| Symbol             | Parameter                     | Test Conditions                                                                                                                                       | Min. | Typ. | Max. | Unit          |
|--------------------|-------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $I_{SD}$           | Source-drain Current          |                                                                                                                                                       |      |      | 60   | A             |
| $I_{SDM}(\bullet)$ | Source-drain Current (pulsed) |                                                                                                                                                       |      |      | 240  | A             |
| $V_{SD}(\ast)$     | Forward On Voltage            | $I_{SD} = 60\text{ A}$ $V_{GS} = 0$                                                                                                                   |      |      | 1.6  | V             |
| $t_{rr}$           | Reverse Recovery Time         | $I_{SD} = 60\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 30\text{ V}$ $T_j = 150\text{ }^\circ\text{C}$<br>(see test circuit, figure 5) |      | 120  |      | ns            |
| $Q_{rr}$           | Reverse Recovery Charge       |                                                                                                                                                       |      | 0.36 |      | $\mu\text{C}$ |
| $I_{RRM}$          | Reverse Recovery Current      |                                                                                                                                                       |      | 6    |      | A             |

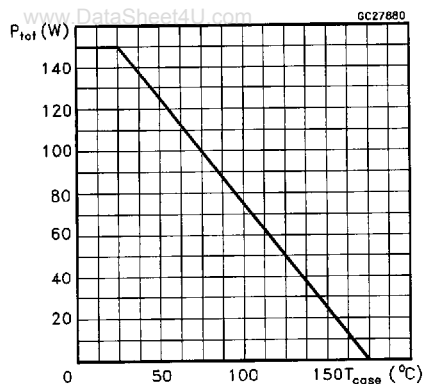
(\*) Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 %  
(•) Pulse width limited by safe operating area

Safe Operating Areas

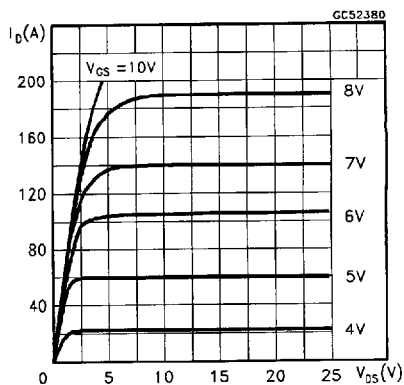
Thermal Impedance



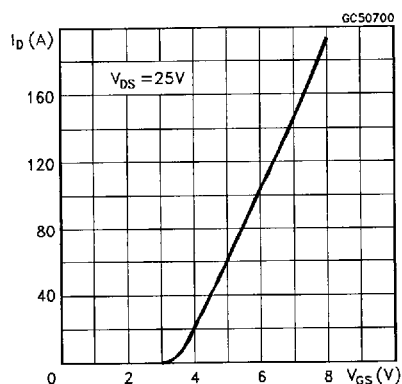
## Derating Curve



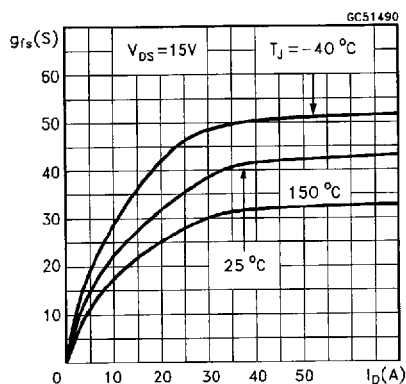
## Output Characteristics



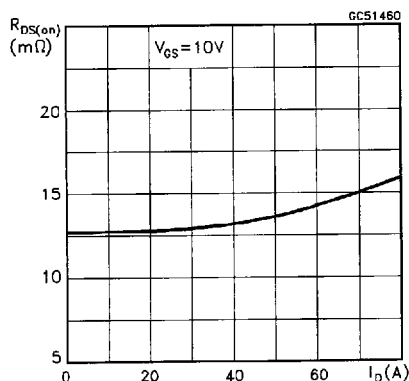
## Transfer Characteristics



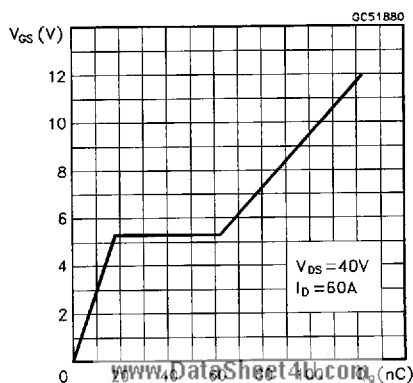
## Transconductance



## Static Drain-source On Resistance

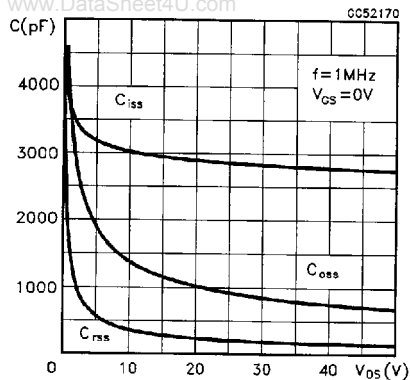


## Gate Charge vs Gate-source Voltage

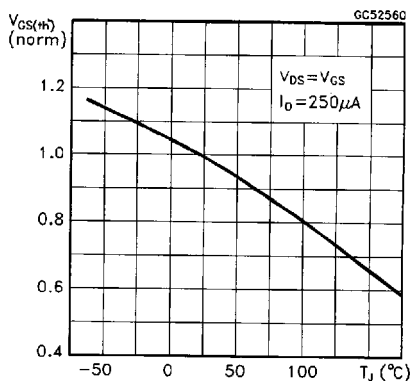


## Capacitance Variations

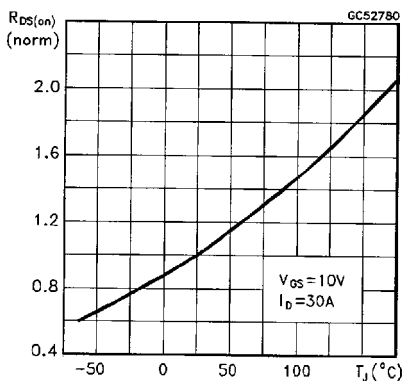
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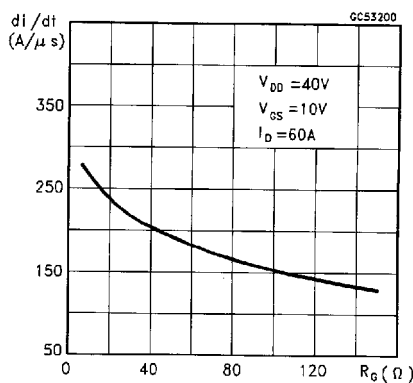
## Normalized Gate Threshold Voltage vs Temperature



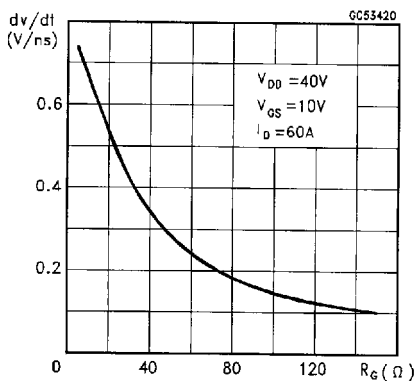
## Normalized On Resistance vs Temperature



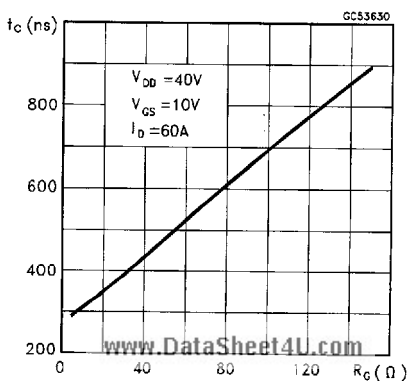
## Turn-on Current Slope

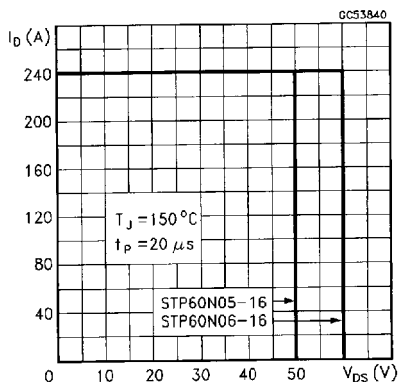
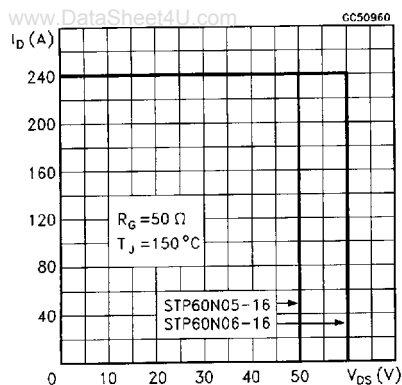


## Turn-off Drain-source Voltage Slope



## Cross-over Time





Source-drain Diode Forward Characteristics

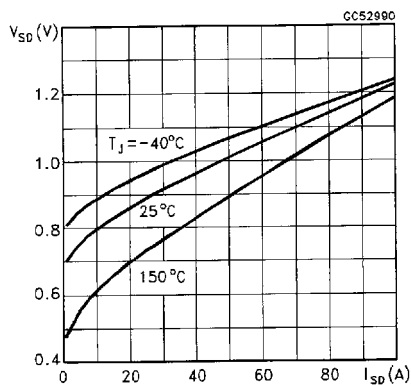


Fig. 1: Unclamped Inductive Load Test Circuits

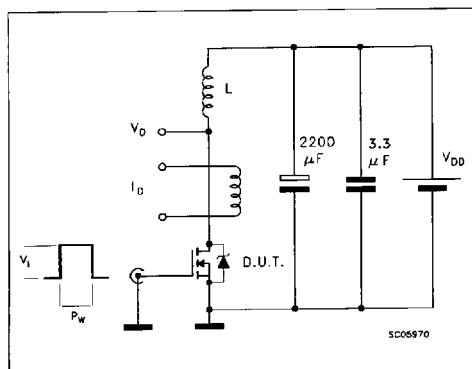
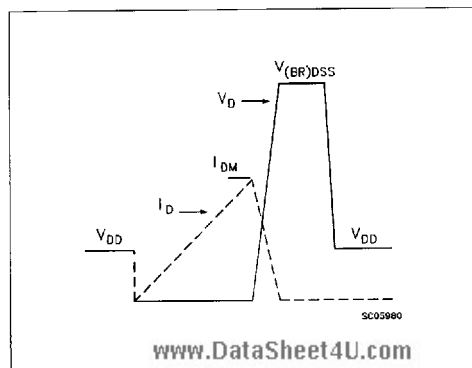
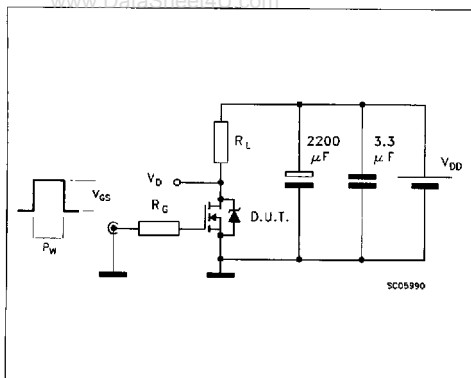


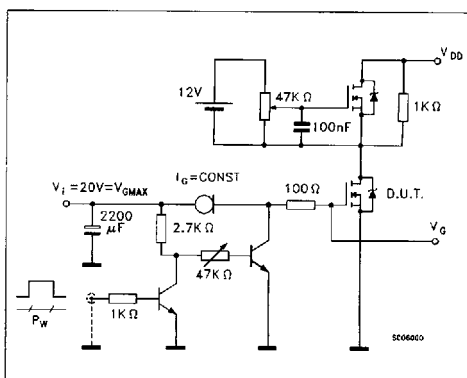
Fig. 2: Unclamped Inductive Waveforms



**Fig. 3: Switching Times Test Circuits For Resistive Load**



**Fig. 4: Gate Charge Test Circuit**



**Fig. 5: Test Circuit For Inductive Load Switching And Diode Reverse Recovery Time**

